

NCE P-Channel Enhancement Mode Power MOSFET

Description

The NCE20PD05 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

 \bullet V_{DS} = -20V,I_D =- 5A

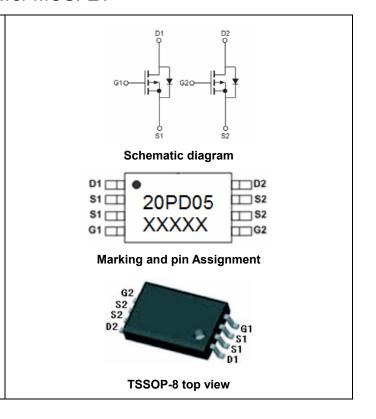
 $R_{DS(ON)}$ < 30m Ω @ V_{GS} =2.5V

 $R_{DS(ON)}$ < 22m Ω @ V_{GS} =4.5V

- High Power and current handing capability
- Lead free product is acquired
- Surface Mount Package

Application

- Battery protection
- Load switch
- Power management



Package Marking And Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
20PD05	NCE20PD05	TSSOP-8	Ø330mm	12mm	3000 units

Absolute Maximum Ratings (TA=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	-20	V	
Gate-Source Voltage	V _{GS}	±12	V	
Drain Current-Continuous	I _D	-5	А	
Drain Current-Pulsed (Note 1)	I _{DM}	-20	А	
Maximum Power Dissipation	P _D	1.6	W	
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55 To 150	$^{\circ}$ C	

Thermal Characteristic

Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{ hetaJA}$	78	°C/W

Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250μA	-20	21	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-20V,V _{GS} =0V	-	-	1	μA



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NCE20PD05

Gate-Body Leakage Current	I _{GSS}	V _{GS} =±12V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	$V_{GS(th)}$	V _{DS} =V _{GS} ,I _D =-250μA	-0.5	-0.7	-1.2	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-4.5V, I _D =-5A	-	24.8	30	mΩ
Diain-Source On-State Resistance		V _{GS} =-2.5V, I _D =-5A	-	32.5	40	mΩ
Forward Transconductance	g FS	V _{DS} =-5V,I _D =-5A	-	15	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}	\/ - 10\/\/ -0\/	-	1025	-	PF
Output Capacitance	Coss	V_{DS} =-10V, V_{GS} =0V, F=1.0MHz	-	167	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0WHZ	-	119	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	10	-	nS
Turn-on Rise Time	t _r	V_{DD} =-10 V , I_{D} =-5 A	-	15	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =-4.5V, R_{GEN} =6 Ω	-	70	-	nS
Turn-Off Fall Time	t _f		-	40	-	nS
Total Gate Charge	Q_g	\/ - 10\/ - 50	-	13	-	nC
Gate-Source Charge	Q_{gs}	V_{DS} =-10V, I_{D} =-5A, V_{GS} =-4.5V	-	2	-	nC
Gate-Drain Charge	Q_{gd}	V _{GS} 4.5V	-	3.4	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V_{SD}	V _{GS} =0V,I _S =-5A	-	-0.75	-1.2	V
Diode Forward Current (Note 2)	Is		-	-	-5	Α

Notes:

- **1.** Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
 4. Guaranteed by design, not subject to production



Typical Electrical and Thermal Characteristics

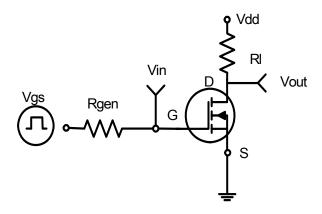


Figure 1:Switching Test Circuit

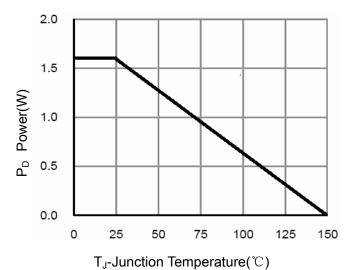


Figure 3 Power Dissipation

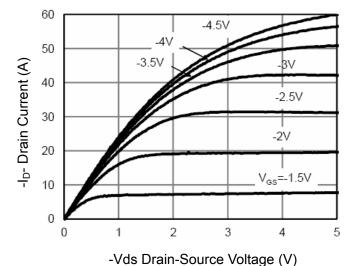


Figure 5 Output Characteristics

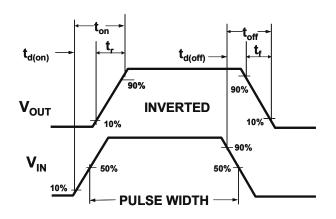


Figure 2:Switching Waveforms

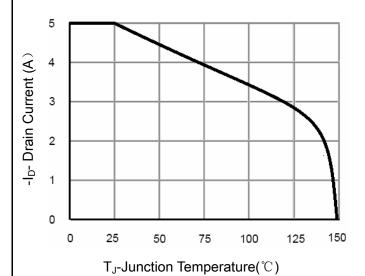


Figure 4 Drain Current

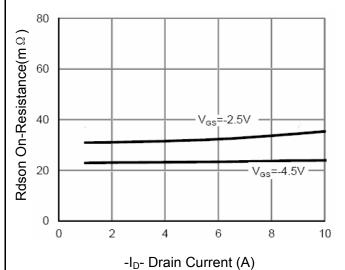
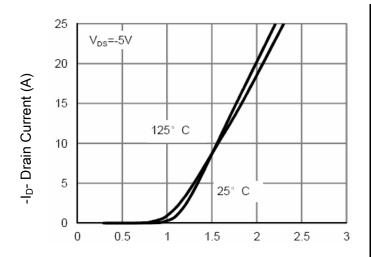
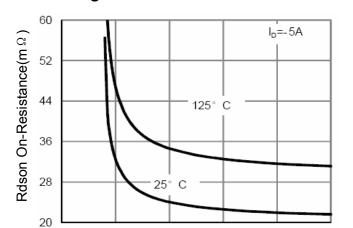


Figure 6 Drain-Source On-Resistance





-Vgs Gate-Source Voltage (V) Figure 7 Transfer Characteristics



4

0

2

-Vgs Gate-Source Voltage (V)

6

8

10

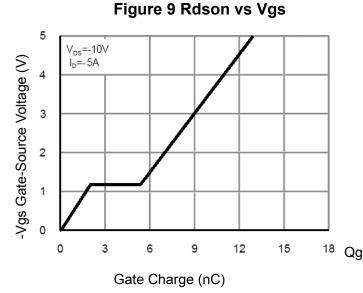


Figure 11 Gate Charge

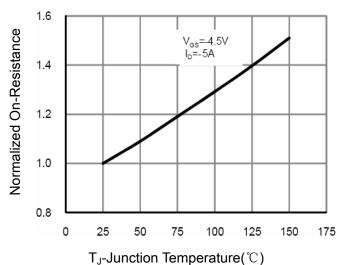
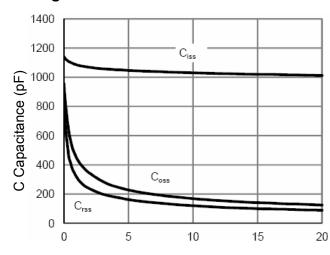


Figure 8 Drain-Source On-Resistance



-Vds Drain-Source Voltage (V)

Figure 10 Capacitance vs Vds

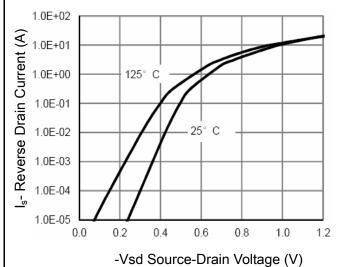


Figure 12 Source- Drain Diode Forward



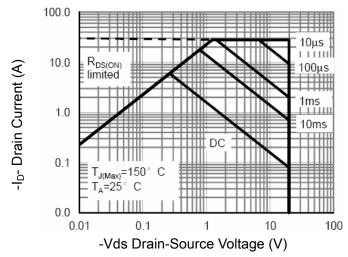


Figure 13 Safe Operation Area

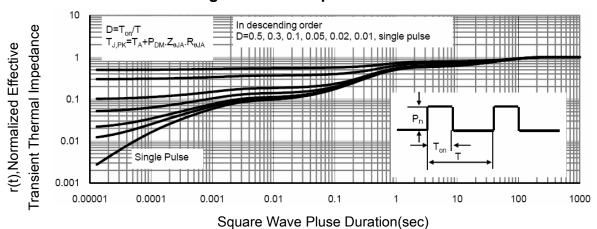
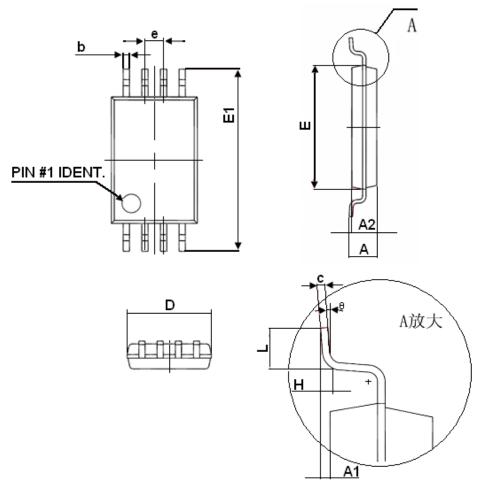


Figure 14 Normalized Maximum Transient Thermal Impedance



Tssop-8 Package Information



Symbol	Dimensions In Millimeters			
Symbol	Min	Max		
D	2.900	3.100		
E	4.300	4.500		
b	0.190	0.300		
С	0.090	0.200		
E1	6.250	6.550		
Α		1.100		
A2	0.800	1.000		
A1	0.020	0.150		
е	0.65(BSC)			
L	0.500	0.700		
Н	0.25(TYP)			
Θ	1°	7°		



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